L Number	Hits	Search Text	DB	Time stamp
1	184843	semiconductor and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/11 16:23
2	5036	(semiconductor and wafer) and (process near1 control)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/11 16:24
3	5036	(semiconductor and wafer) and (process near control)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/11 16:29
4	3	"5990488"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/11 16:28
5	9	("4467400" | "4479088" | "4517659" | "4920454" | "5309011" | "5391892" | "5514884" | "5648661" | "5654588").PN.	USPAT	2003/01/11 16:26
6	132	(semiconductor and wafer) and ((process near control) near1 (module monitor))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/11 16:30
7	29	((semiconductor and wafer) and ((process near control) near1 (module monitor))) and (chip die)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/11 16:30
8	0	5990488.URPN.	USPAT	2003/01/11 16:42
9	0	5990488.URPN.	USPAT	2003/01/11 16:42
10	9	("4467400" | "4479088" | "4517659" | "4920454" | "5309011" | "5391892" | "5514884" | "5648661" | "5654588").PN.	USPAT	2003/01/11 16:42